Attorney Docket No.: 0254-094-CIP4-C1

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Memory Expansion and Chip Scale Stacking System and Method

Application No.:

10/814,530

Filing Date:

03/31/2004

Inventor:

Russell Rapport, et al.

Assignee:

Staktek Group, L.P.

Examiner:

TBA

Group:

TBA

INFORMATION DISCLOSURE STATEMENT

Commissioner for Patents PO Box 1450 Alexandria, VA 22313-1450

Pursuant to the guidelines for Information Disclosure Statements, 37 C.F.R. §§ 1.97-1.98, attached hereto is PTO Form 1449 (six sheets) with references listed for consideration by the Office.

In accordance with 37 C.F.R. § 1.98(a), copies of the listed written references are being provided.

In accordance with 37 C.F.R. §§ 1.97(g)-(h), the filing of this Information Disclosure Statement shall not be construed as a representation that a search has been made or an admission that the information cited in the statement is, or is considered to be, material to patentability as defined in 37 C.F.R. § 1.56(b) or prior art under 35 U.S.C. §§ 102 or 103.

This Information Disclosure Statement is being filed before receipt of the first Office action, so no fee is believed to be due. The Commissioner is hereby authorized to charge any fees which may be required in connection with the filing, or to credit any overpayment to Deposit Account No. 50-0897, upon which account the undersigned has the authority to sign. A duplicate copy of Form 1449 is enclosed.

Respectfully submitted,

By:

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April (92004)

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APPLICANT Rapport, et al

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Sheet 4 of 6 U.S. Dept. of Commerce Patent and Trademark Office ATTY. DOCKET NO. SERIAL NO. Form PTO-1449 (Modified) (Rev. 11/92) 0254-094-CIP4-C1 10/814,530 INFORMATION DISCLOSURE STATEMENT BY APPLICANT APPLICANT (Use several sheets if necessary) Rapport, et al **GROUP FILING DATE** 3/31/04 (37 CFR 1.98(b)) U.S. PATENT DOCUMENTS Class Filing Date (if Subclass *Examiner Patent Issue appropriate) Patentee Initial Number Date 10/23/2001 438/113 6,620,651B2 9/16/2003 He et al. US2002/0139577A 174/261 3/27/2001 10/3/2002 Miller, Charles A. US2002/0164838A 438/107 6/5/2001 Nov-02 Moon et al. US2002/0180022A 7/19/2002 257/686 12/5/2002 Emoto, Yoshiaki 257/686 5/4/1998 6,072,233 6/6/2000 Corisis et al. 317/101 04/25/1966 04/01/1969 Hyltin 3,436,604 317/101 05/06/1971 3,746,934 07/17/1973 Stein 12/03/1969 29/628 3,772,776 11/20/1973 Weisenburger 09/20/1979 09/08/1981 361/414 4,288,841 Gogal 12/13/1985 439/69 09/29/1987 Coller, et al 4,696,525 361/386 07/01/1986 4,823,234 04/18/1989 Konishi, et al 01/29/1988 361/383 05/23/1989 Berhold 4,833,568 439/67 08/03/1989 4,911,643 03/27/1990 Perry, et al 05/05/1989 361/388 08/28/1990 Lauffer, et al 4,953,060 357/74 11/04/1988 09/11/1990 Eide 4,956,694 10/28/1987 437/7 4,983,533 01/08/1991 Go FOREIGN PATENT OR PUBLISHED FOREIGN PATENT APPLICATION Translation Class Subclass Document Number Date Country Yes No OTHER DOCUMENTS (INCLUDING AUTHOR, TITLE, DATE, PERTINENT PAGES, ETC.) Dense-Pac Microsystems, 256 Megabyte CMOS DRAM DP3ED32MS72RW5

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IBM Preliminary 168 Pin SDRAM Registered DIMM Functional Description & Timing Diagrams

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